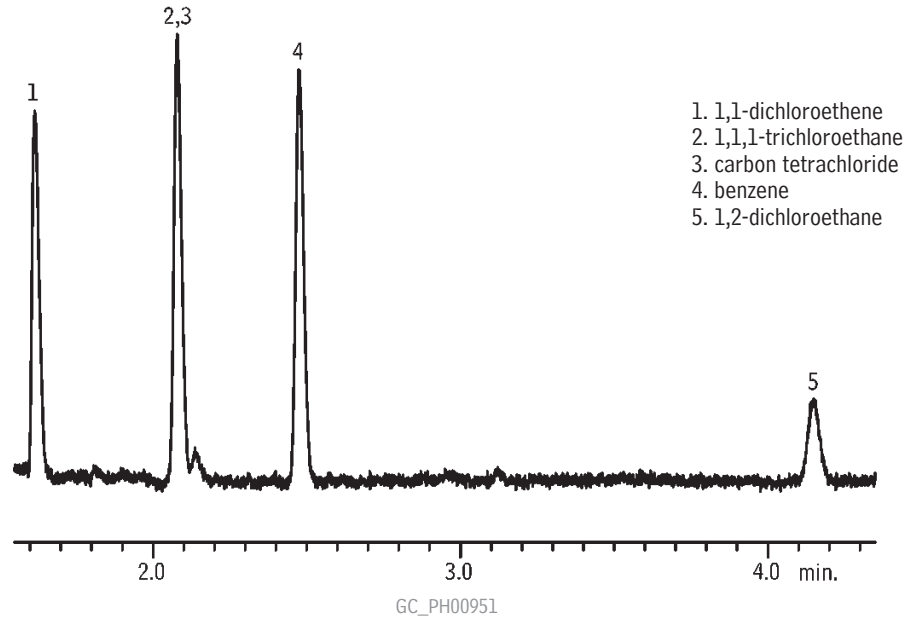


Residual Solvents Class 1 Stabilwax® (G16)



Column:	Stabilwax®, 30m, 0.32mm ID, 0.25µm (cat.# 10624)	Headspace Conditions
Sample:	USP Stock Mixture USP<467>	Instrument: Overbrook Scientific HT200H
Residual	Solvents Class 1 Mix (cat.# 36279) in 20mL headspace vial (cat.# 24685), water diluent	Syringe temp.: 100°C
Inj.:	headspace injection (split ratio 1:5), 2mm splitless liner IP deactivated (cat.# 20712)	Sample temp.: 80°C
Inj. temp.:	140°C	Sample equil. time.: 45 min.
Carrier gas:	helium, constant flow	Injection vol.: 1.0mL
Flow rate:	2.15mL/min., 35.2cm/sec.	Injection speed: setting 8
Oven temp.:	50°C for 20 min. to 165°C @ 6°C/min. (hold for 20 min.)	Injection dwell: 5 sec.
Det.:	FID @ 250°C	

Restek Corporation 110 Benner Circle Bellefonte, PA 16823
814-353-1300 • 800-356-1688 • Fax: 814-353-1309 • www.restek.com